### Invariant-based Theory of Composites

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# Tensile and Compressive E<sub>1</sub>°/Trace

Room temp dry (with diamond), low temp dry, high temp dry and wet







### Absolute Value of Trace [A°] Tensile

![](_page_3_Figure_1.jpeg)

# Normalized Fabric Stiffness: E<sub>1</sub>°/Trace

![](_page_4_Figure_2.jpeg)

### CFRP Tape: Trace Values +

![](_page_5_Figure_2.jpeg)

![](_page_6_Figure_0.jpeg)

### CFRP Fabric: Trace Values +

![](_page_7_Figure_2.jpeg)

### Some Practical Uses of Trace

- Only invariant quantity that represents total stiffness potential of each composite material
- All stiffness components are fractions of trace
- One test can tell all about a given material
- Change in material is defined by their trace
- It can measure the quality of lamination; any defect or damage will lower trace value
- Test laminate: closer to real structure
- Track temperature effect by change in trace

### Stiffness and Compliance Matrices

$$
[\mathbf{Q}] = \begin{bmatrix} \frac{\mathbf{E}_{\mathbf{x}}}{1 - \nu_{\mathbf{x}} \nu_{\mathbf{y}}} & \frac{\nu_{\mathbf{y}} \mathbf{E}_{\mathbf{x}}}{1 - \nu_{\mathbf{x}} \nu_{\mathbf{y}}} & 0 \\ \frac{\nu_{\mathbf{x}} \mathbf{E}_{\mathbf{y}}}{1 - \nu_{\mathbf{x}} \nu_{\mathbf{y}}} & \frac{\mathbf{E}_{\mathbf{y}}}{1 - \nu_{\mathbf{x}} \nu_{\mathbf{y}}} & 0 \\ 0 & 0 & \mathbf{E}_{\mathbf{s}} \end{bmatrix} \quad [\mathbf{S}] = \begin{bmatrix} \frac{1}{\mathbf{E}_{\mathbf{x}}} & -\frac{\nu_{\mathbf{y}}}{\mathbf{E}_{\mathbf{y}}} & 0 \\ -\frac{\nu_{\mathbf{x}}}{\mathbf{E}_{\mathbf{x}}} & \frac{1}{\mathbf{E}_{\mathbf{y}}} & 0 \\ 0 & 0 & 1/\mathbf{E}_{\mathbf{s}} \end{bmatrix}
$$

Reciprocal relation:  $v_x E_y = v_y E_x$ 

Laminate in-plane stiffness in terms of ply stiffness [Q]:

$$
[\mathbf{A}^{\bigstar}] = \frac{1}{h} [\mathbf{A}] = \frac{1}{h} \sum_{i=1}^{m} [\mathbf{Q}^{'}]^{(i)} h^{(i)} = \sum_{i=1}^{m} [\mathbf{Q}^{'}]^{(i)} \frac{h^{(i)}}{h} = \sum_{i=1}^{m} [\mathbf{Q}^{'}]^{(i)} v^{(i)}
$$

where  $v^{(i)}$  = fraction of the i-th ply group

### Laminate Compliance Components

$$
\begin{aligned} [\boldsymbol{a}] &= [\boldsymbol{A}]^{-1}, |\boldsymbol{A}| \\ &= (A_{11}A_{22} - A_{12}^2)A_{66} + 2A_{12}A_{26}A_{16} - A_{11}A_{26}^2 \\ &- A_{22}A_{16}^2 \end{aligned}
$$

$$
a_{11} = \frac{(A_{22}A_{66} - A_{26}^2)}{|A|}, a_{22} = \frac{(A_{11}A_{66} - A_{16}^2)}{|A|}, a_{12} = \frac{(A_{16}A_{26} - A_{12}A_{66})}{|A|}
$$

$$
a_{66} = \frac{(A_{11}A_{22} - A_{12}^2)}{|A|}, a_{16} = \frac{(A_{12}A_{26} - A_{22}A_{16})}{|A|}, a_{26} = \frac{(A_{12}A_{16} - A_{11}A_{26})}{|A|}
$$

 $(3.4)$ 

### Laminate Engineering Constants

$$
E_1^o=\frac{1}{a_{11}}^*\,,E_2^o=\frac{1}{a_{22}}^*\,,E_6^o=\frac{1}{a_{66}}^*
$$

$$
v_{21}^o = -\frac{a_{21}}{a_{11}}, v_{61}^o = \frac{a_{61}}{a_{11}}, v_{62}^o = \frac{a_{62}}{a_{11}}
$$

$$
v_{12}^o = -\frac{a_{12}}{a_{22}}, v_{16}^o = \frac{a_{16}}{a_{66}}, v_{26}^o = \frac{a_{26}}{a_{66}}
$$

### Input Data: Ply Stiffness and Strength

![](_page_12_Picture_6.jpeg)

![](_page_12_Picture_7.jpeg)

![](_page_12_Picture_8.jpeg)

### Ply & Laminate Stiffness Matrix & Trace

![](_page_13_Figure_1.jpeg)

### Master Ply Stiffness: Trace Normalized

Carbon/epoxy ply stiffness in trace normalized factors

![](_page_14_Picture_21.jpeg)

 $Q_{xx} = Q_{xx}^*$  x Tr = 0.883 x 187 = 165 GPa

# Median and cv of  $E_{x}/$ Trace [Q]

![](_page_15_Figure_1.jpeg)

## Dispersion of  $Q_{11}$ <sup>\*</sup> at 0° and 90°

![](_page_16_Figure_1.jpeg)

### Bay-by-bay not Optimized

![](_page_17_Figure_1.jpeg)

### Acoustic Response of  $[\pm 45/0/90]_{S}$  Coupons

Normal ply thickness: 0.12 mm Thin ply: 0.04 mm

Note extensive signals after FPF Less signals after much higher FPF

![](_page_18_Figure_5.jpeg)

**Top and side views of failed coupon, same total thickness Note extensive delamination of thick ply coupon on the left**

### Tension Fatigue at RT - (50/40/10)

**σmax = 70 ksi (70% static), R = 0.1, f = 5 Hz, after 73,000 cycles Ply thickness = 0.04 mm, Laminate thickness = 3.2 mm**

**[45/0<sup>2</sup> /-45/90/45/0<sup>2</sup> /45/0]5S [45<sup>5</sup>**

![](_page_19_Picture_3.jpeg)

**/010/-45<sup>5</sup> /90<sup>5</sup> /45<sup>5</sup> /010/45<sup>5</sup> /0<sup>5</sup> ] S**

![](_page_19_Picture_5.jpeg)

### Wide-range GSM to Meet Requirement

![](_page_20_Figure_1.jpeg)

### Advantages of Thin Plies

- Micro cracking and delamination suppressed
- Easy formation of bi-angle C-Ply to improve handling, and avoid layup of extra layers
- Good building block from bi- to tri-angle tape
- Provide design options for thin fuselage skins
- Increase layup speed with multi-angle tape
- Easy to reach homogenized laminates
- Once homogenized, options become possible: asymmetry, single ply drop, and optimization

### Too Many Stacking Permutations **Jeremy Sanford, Spirit**

![](_page_22_Figure_1.jpeg)

![](_page_23_Picture_373.jpeg)

 $Qxx^*$ Qss\* Tr, GPa Ey\* nu/x\* Material [0]  $Qyy^*$ Trace\* Ex\* 0.036 IM7/977-3 0.88 0.046 218 1.00 0.88 0.046  $0.35$ T800/Cytec 0.90 0.050  $0.027$ 183 1.00 0.89  $0.049$  $0.40$ T700 C-Ply  $0.88$ 0.058 0.034 139 1.00 0.87  $0.058$  $0.30$ AS4/3501 0.86 0.056 0.044 162 1.00 0.85  $0.055$  $0.30$ IM6/epoxy  $0.32$ 0.88  $0.049$ 0.036 232 1.00 0.88  $0.048$ AS4/F937 0.89 0.058 0.027 168 1.00 0.88  $0.057$  $0.30$ T300/N5208 0.88 0.050 0.035 206 1.00 0.88  $0.050$  $0.28$ Master ply 0.883 0.0502 0.0348 183 1.000 0.876  $0.0500$ 0.300 Coeff var 1.1%  $0.44%$ 0.53%  $1.2%$  $0.5%$ 4.1% **Laminates have lower cv than plies | \* | normalized by Trace**  $[0/\text{\texttt{±30}}]:1:0$  $A11*$  $A22*$ A66\* Tr, GPa Trace\*  $E1*$ E2\* nu/21\* IM7/977-3 0.65 0.091  $0.13$ 218 1.00 0.072  $1.2$  $0.52$ T800/Cytec  $1.3$ 0.66 0.091  $0.13$ 183 1.00  $0.50$ 0.069 T700 C-Ply 0.64 0.099  $0.13$ 139 1.00  $0.52$ 0.079  $1.1$ AS4/3501  $0.101$  $0.13$ 162 1.00  $0.53$ 0.084  $1.0$  $0.64$ IM6/epoxy  $1.2$ 0.65 0.093  $0.13$ 232 1.00  $0.52$ 0.074 AS4/F937 0.65 0.096  $0.13$ 168 1.00  $0.50$ 0.074  $1.2$ T300/N5208  $1.2$ 0.65 0.093  $0.13$ 206 1.00  $0.52$ 0.075 0.0745 Master ply 0.647 0.0930 0.130 183 1.000 0.515 1.18 Coeff var 0.57% 0.36% 0.16% 1.0%  $0.5%$ 8.4%

[0/ ±30]

![](_page_24_Picture_38.jpeg)

![](_page_24_Picture_39.jpeg)

### Normalized Master Laminate Factors

Need only one test:  $E_x/0.876 = Tr [A^\circ] >>$  factors for  $E_1^\circ$ ,  $E_2^\circ$ ,  $v_x$ ,  $E_6^\circ$ Zero test: If you believe in rule of mixtures that  $\mathsf{E}_{\mathsf{x}}$  =  $\mathsf{v}_{\mathsf{f}}\mathsf{E}_{\mathsf{f}}$ Or another single test of  $[\pi/4]$ : E<sub>1</sub>°/0.337 = Tr [A°], ...

![](_page_25_Picture_126.jpeg)

Examples: For  $[0/±45]$ ,  $E_1^{\circ} = 0.377$  Tr;  $E_6^{\circ} = 0.161$  Tr (shear test can be avoided) For C-Ply 55, Tr = 139 GPa,  $E_1^{\circ}$  = 0.377 x 139 = 52.4 GPa;  $E_6^{\circ}$  = 0.161 x 139 = 22.4 GPa For T800/Cytec, Tr = 183 GPa, ,  $E_1^{\circ}$  = 0.377 x 183 = 69.0;  $E_6^{\circ}$  = 0.161 x 183 = 29.4 GPa

### How Many Specimens: 1 or 0

 $E_f \gg >> \sum_{x} \sum_{y} \sum_{y} \sum_{z}$  Trace [Q]  $\gg >>$  Laminate stiffness:  $V_f$  0.88

![](_page_26_Picture_33.jpeg)

## Lowest Cost Layup of Thick-thin C-Ply

![](_page_27_Picture_276.jpeg)

### A Master Laminate Design Chart

Smooth lines = trace normalized =  $E_1^*$ , GPa ; Dots =  $E_6/E_1$ 

![](_page_28_Figure_2.jpeg)

![](_page_29_Figure_0.jpeg)

### Plane Elasticity & Bending Equations

Plane elasticity: 
$$
a_{22}^* \frac{\partial^4 F}{\partial x^4} + (2a_{12}^* + a_{66}^*) \frac{\partial^4 F}{\partial x^2 \partial y^2} + a_{11}^* \frac{\partial^4 F}{\partial y^4} = 0
$$
.

$$
\text{Place bending: } D_{11} \frac{\partial^4 w}{\partial x^4} + 2(D_{12} + 2D_{66}) \frac{\partial^4 w}{\partial x^2 \partial y^2} + D_{22} \frac{\partial^4 w}{\partial y^4} = 0
$$

![](_page_30_Picture_59.jpeg)

![](_page_30_Picture_60.jpeg)

### Lekhnitskii's Elasticity Solutions

$$
k = -\mu_1 \mu_2 = \sqrt{\frac{E_1}{E_2}}
$$
  
=  $-i(\mu_1 + \mu_2) = \sqrt{2(\frac{E_1}{E_2} - \nu_1) + \frac{E_2}{C_2}}$ 

Key parameters: *k*, *n* Open hole tension

n

![](_page_31_Figure_3.jpeg)

![](_page_31_Figure_5.jpeg)

![](_page_31_Figure_6.jpeg)

# Same Solutions for 8 CFRP's for [0/±30]

![](_page_32_Picture_17.jpeg)

Median values can be used for most cases with error less than experimental

Exact solutions from Lekhnitskii's *Anisotropic Plates*

### Solutions for Different Laminates

![](_page_33_Picture_8.jpeg)

Median values can be used for different laminates with error less than experimental

### One Test for Trace = Multiple Solutions

![](_page_34_Picture_142.jpeg)

# Measurement of Trace from E<sub>1</sub>°

Material: T800/AR250

![](_page_35_Figure_2.jpeg)

# Scaling by Trace for Material/Laminate

### Giulio Romeo

![](_page_36_Picture_2.jpeg)

### Scale materials: same  $[0/±45/90]_{8S}$  Scale laminates: same T300/N5208

![](_page_36_Picture_35.jpeg)

![](_page_36_Picture_36.jpeg)

### Scaling by Trace for Panel Buckling

Giulio Romeo

![](_page_37_Picture_10.jpeg)

### Ply Strain and Stress of a Laminate

![](_page_38_Figure_1.jpeg)

Since ply and laminate strains are equal, strain-based failure criteria are functions of ply angles only, independent of ply composition of the laminate. So a strain-based criterion is the same for all laminates

Ply stress various from ply to ply depending on the ply angles. The stiffer ply will have higher ply stress. Unlike strain-based failure, stress-based failure tensors [F] and {F} are functions of not only each ply angle but also ply composition of the laminate. Thus each laminate has its own failure envelope.

## Ply-by-Ply vs Homogenized Plate

**Ply-by-ply R(i) of a laminated anisotropic or orthotropic plate**

![](_page_39_Figure_2.jpeg)

**Anisotropic Tsai-Wu criterion: F11, . . . F16; F<sup>1</sup> , F<sup>2</sup> , F<sup>6</sup>**

**Back to the basics: many closed-form and FEM solutions easily applied; speed increases by n (number of plies) in model formation and stress recovery**

### Successive Increase in Ply Angles

![](_page_40_Figure_1.jpeg)

### Omni Strain FPF Envelopes: C-Ply 64

![](_page_41_Figure_1.jpeg)

Ply Polar angle of radial strain vector: 0 to 2π @15° increments

![](_page_41_Picture_57.jpeg)

### Omni Envelope in Polar Plot

![](_page_42_Figure_1.jpeg)

### Omni Envelope in Cartesian

![](_page_43_Figure_1.jpeg)

### Poisson's Ratio of CFRP Laminates

![](_page_44_Figure_1.jpeg)

### Poisson's Correction for Omni strain

![](_page_45_Figure_1.jpeg)

2<sup>nd</sup> quadrant of strain envelope and all 4th quadrant of strain envelope Angle measured clockwise from 0 degree along x-axis; 90 degree, y-axis

### Poisson's Correction for Omni strain

![](_page_46_Figure_1.jpeg)

2<sup>nd</sup> quadrant of strain envelope and all 4th quadrant of strain envelope Angle measured clockwise from 0 degree along x-axis; 90 degree, y-axis

### Preferred Coupons for Master Envelopes

![](_page_47_Figure_1.jpeg)

### Uniaxial Data validating Omni Envelope

![](_page_48_Figure_1.jpeg)

# Omni Strain Envelope for T800/Cytec

All uniaxial tensile data can be placed on this principal strain plane

![](_page_49_Figure_2.jpeg)

# Omni Strain Envelope for T800/Cytec

All uniaxial tensile data can be placed on this principal strain plane

![](_page_50_Figure_2.jpeg)

### Cartesian Plot of Omni Strain: T800/Cytec

![](_page_51_Figure_1.jpeg)

## Omni Strain FPF and Circle, and Tr [G]

![](_page_52_Figure_1.jpeg)

![](_page_53_Picture_37.jpeg)

![](_page_53_Figure_1.jpeg)

Omni circle strain, 10-3

![](_page_54_Figure_0.jpeg)

![](_page_55_Figure_0.jpeg)

### Impact Resistance of  $[\pi/6]$  Laminates

### **Spiral stacking**

![](_page_56_Figure_2.jpeg)

# Stacking Options of [π/4] C-Ply

Asymm (T) vs symm (S); w vs w/o seams; 150 vs 268 gsm; test 1 vs 2

![](_page_57_Picture_59.jpeg)

![](_page_57_Figure_3.jpeg)

**[(0/45)/(90/-45)] Right handed spiral**

![](_page_57_Figure_5.jpeg)

**[(±22.5)/(-67.5/67.5)] Left handed spiral**

## Homogeneity: Symmetry; 150 vs 268

Smooth coupon with load applied along a [0] ply

![](_page_58_Figure_2.jpeg)

![](_page_58_Figure_3.jpeg)

### Laminates With or Without Seams

Laminates w/o seams: Laminates with seams: w and w/o symmetry

# with symmetry only

![](_page_59_Figure_3.jpeg)

### Asymmetric vs Symmetric Laminates

![](_page_60_Figure_1.jpeg)

# Smooth vs OHT Coupons from [π/4]

With and without: symmetry and seams; thick-thin plies, load along [0] and bisector

![](_page_61_Figure_2.jpeg)

### Open Hole: a safe & simple approach

![](_page_62_Figure_1.jpeg)

### Accelerated Allowable Generation

![](_page_63_Figure_1.jpeg)

![](_page_64_Figure_0.jpeg)

### Master Ply and its Laminates

- Plane stress stiffness [Q] is better represented by its invariant trace:  $Q_{xx} + Q_{yy} + 2Q_{ss} - a$  linear scaling factor
- When normalize by trace [Q\*] plies and laminates are insensitive among many composite plies justifying a master ply
- The same invariance holds from ply to in-plane, and to flexure (not shown here) – to scale design is made easy
- Power of bi- and tri-angle tapes can save cost through 1- or 2-axis; increase CAI through 6-angle laminates
- Certification of asymmetric layup and homogenization of composite laminates can be accelerated with fewer coupons, and more simulation guided by invariants
- Recommend laminates with holes as test coupons

## Opportunities in Composites Design

- Master fundamental theories, like invariants for Master ply, a one parameter for design
- Multi-angle tape layup can achieve >2X in speed and 6-angle laminates for increased CAI while limited to 1- or 2-axis layup, no more 4-axis
- Thin plies can increase toughness and homogenization - amenable to optimization, and ply angle used as a continuous variable
- Simulation will guide tests for hot-wet, fatigue, CAI, damage tolerance, and micromechanics
- Design allowable and certification can be simplified by testing laminates with open hole replacing smooth coupons of plies and laminates